

US2A THRU US2M

VOLTAGE RANGE 50 to 1000 Volts  
CURRENT 2.0 Ampere

Features

- Fast recovery glass passivated chip
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering: 260°C/10S at terminals
- Component in accordance to ROHS 2002/95/1 and WEEE 2002/96/EC



DO-214AC (SMA)

Mechanical Data

- Case: JEDEC SOD-123FL mold plastic Body over glass passivated chip
- Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D
- Polarity: Laser band denote cathode band
- Weight: 0.0024 ounce, 0.068 gram

Maximum Ratings and Electrical Characteristics

- Ratings at 25°C ambient temperature unless otherwise specified
- Single phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

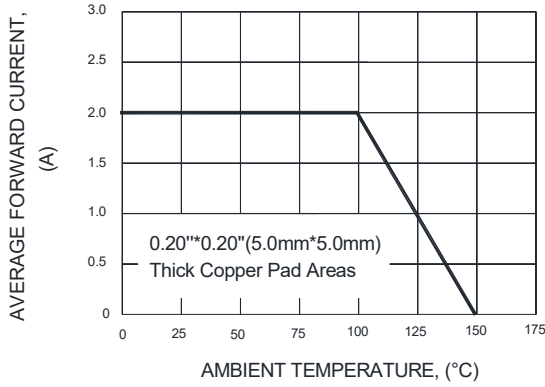
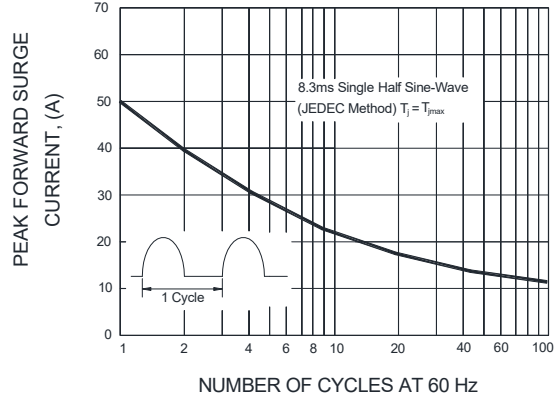
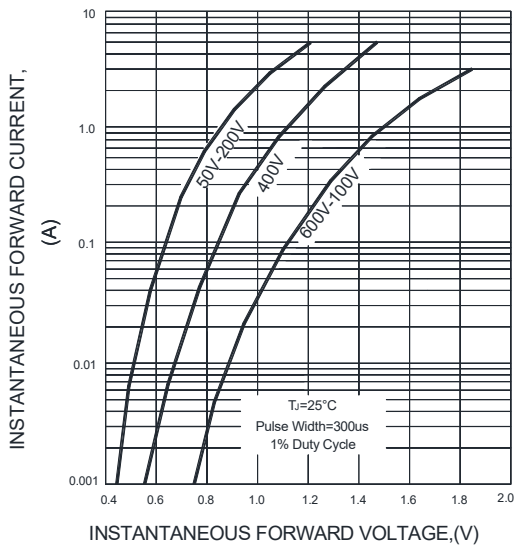
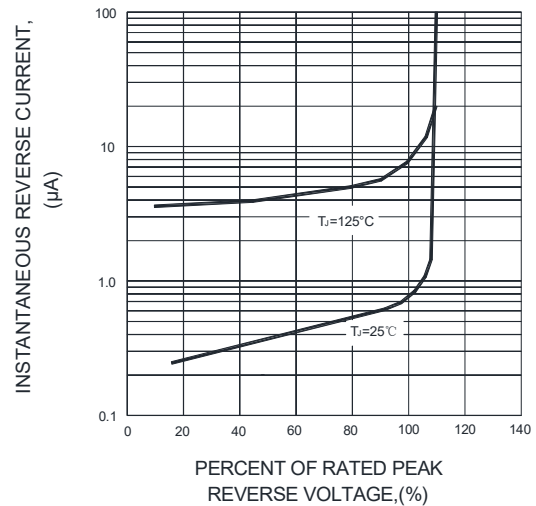
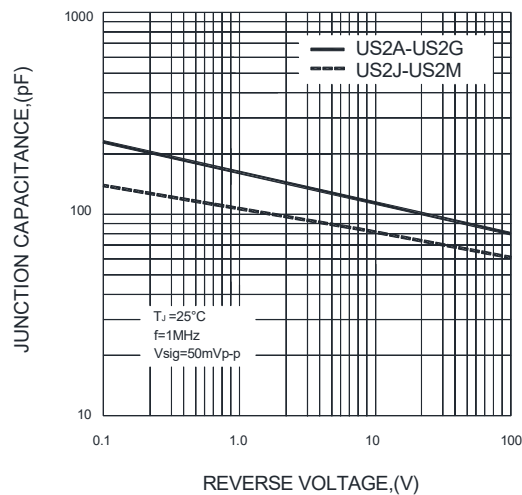
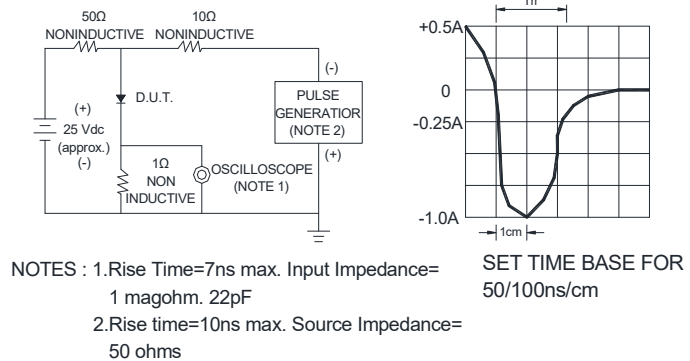
TYPE NUMBER	SYMBOLS	US 2A	US 2B	US 2D	US 2G	US 2J	US 2K	US 2M	UNIT
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current At T <sub>A</sub> =100°C	I <sub>(AV)</sub>	2.0							Amps
Peak Forward Surge Current 8.3ms single half sine wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	50							Amps
Maximum Instantaneous Forward Voltage per at 2.0A	V <sub>F</sub>	1.0		1.30		1.70		Volts	
Maximum DC Reverse Current at rated DC Blocking Voltage	T <sub>A</sub> = 25°C	5.0							µA
	T <sub>A</sub> = 125°C	100							
Typical Reverse Recovery Time Test conditions I <sub>F</sub> = 0.5A, I <sub>R</sub> = 1.0A, I <sub>RR</sub> = 0.25A	T <sub>RR</sub>	50				75			nS
Typical Junction Capacitance (Note 2)	C <sub>J</sub>	50				30			pF
Typical Thermal Resistance (Note 1)	R <sub>θJA</sub>	50							°C/W
	R <sub>θJL</sub>	17							
Operating Junction Temperature	T <sub>J</sub>	(-55 to +150)							°C
Storage Temperature Range	T <sub>STG</sub>	(-55 to +150)							°C

Notes:

1. Thermal resistance from Junction to ambient and from junction to lead mounted on PCB. with 0.2×0.2"(5.0 × 5.0mm) copper pad areas.
2. Measured at 1.0MHz and applied reverse voltage of 4.0V

**US2A THRU US2M**

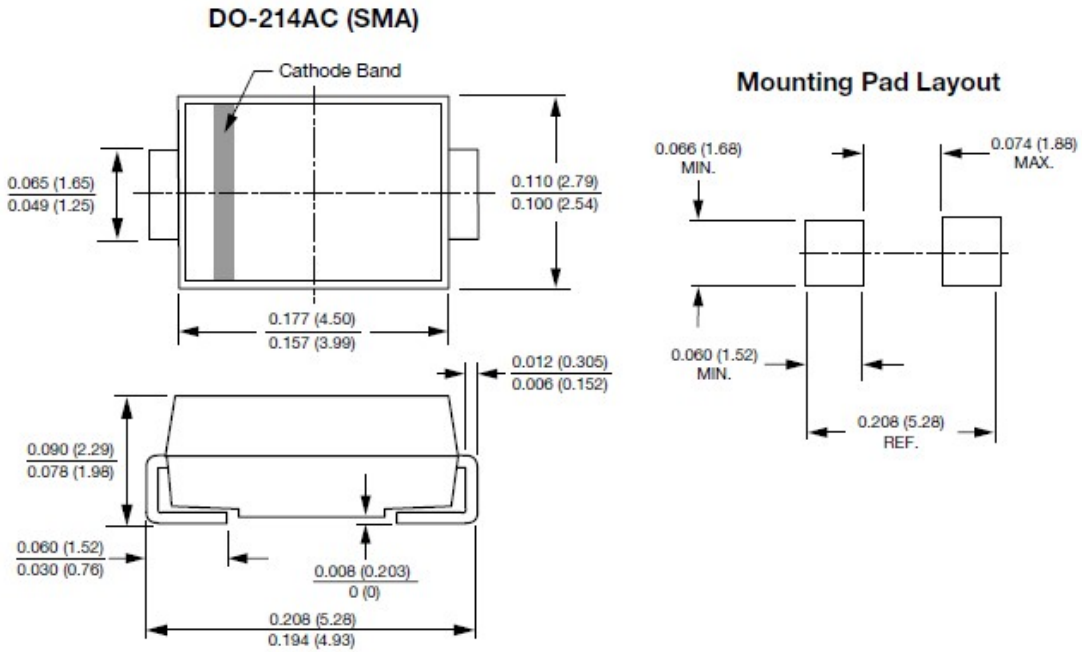
 VOLTAGE RANGE 50 to 1000 Volts  
 CURRENT 2.0 Ampere

**Ratings and Characteristic Curves (TA=25°C unless otherwise noted)**
**FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE**

**FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT**

**FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS**

**FIG.4-TYPICAL REVERSE CHARACTERISTICS**

**FIG.5-TYPICAL JUNCTION CAPACITANCE**

**FIG.6-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC**


**US2A THRU US2M**

VOLTAGE RANGE 50 to 1000 Volts

CURRENT 2.0 Ampere

**Package Outline Dimensions in inches (millimeters)**


## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [Rectifiers](#) category:*

*Click to view products by [LangJie](#) manufacturer:*

Other Similar products are found below :

[70HFR40](#) [FR105 R0](#) [RL252-TP](#) [1N5397](#) [1N4005-TR](#) [1N4007-BP](#) [UFS120Je3/TR13](#) [20ETS12S](#) [RRE02VS6SGTR](#) [MS306](#) [A1N5404G-G](#)  
[CRF02\(T5L,TEMQ\)](#) [ACGRB207-HF](#) [CLH07\(TE16L,Q\)](#) [CLH03\(TE16L,Q\)](#) [1N5395-TP](#) [UES1302](#) [ACGRC307-HF](#) [ACEFC304-HF](#) [DZ-](#)  
[1380](#) [85HFR60](#) [40HFR60](#) [70HF120](#) [85HFR80](#) [SCF7500](#) [SM100](#) [ACGRA4001-HF](#) [SKN70/08](#) [NTE5819](#) [NTE5827](#) [NTE5828](#) [NTE5911](#)  
[NTE5915](#) [NTE6104](#) [NTE6163](#) [NTE6164](#) [NTE6165](#) [NTE6364](#) [TSD3G](#) [SET130312](#) [NRVUS110VT3G](#) [UES1106](#) [UES1306](#)  
[NRVUS240VT3G](#) [D5FE60-5063](#) [R4000GPS-TP](#) [D4015L56TP](#) [UES1306HR2](#) [FX20K120](#) [D20XB60-7101](#)